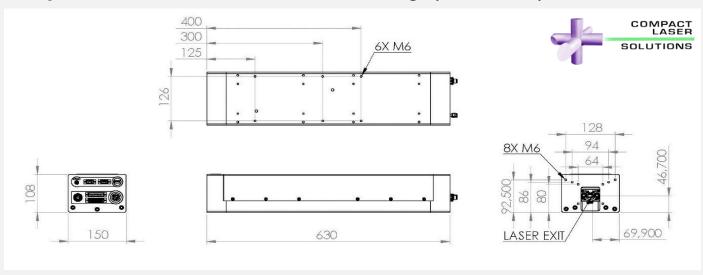


CONQUEROR ALL IN ONE - Model 3 Lambda

Betriebsart Mode of Operation	gepulst / pulsed		
Leistungsklasse Power Class	30W CW @ 1064nm		
Wellenlänge Wavelength	1064nm	532nm	355nm
Strahlqualität Beam Mode	TEM ₀₀		
* M ²	< 1.3		
Polarisation	Linear > 100:1		
Max. Pulsenergie Max. Pulse Energy	600µJ	300µJ	300µJ
Minimale Pulsweite Minimal Pulse Width	< 12ns	< 10ns	< 8ns
Repetitionsrate Repetition Rate	1 Hz - 500kHz		
mittlere Leistung Average Output Power	24W @ 50kHz <14ns	12W @ 50kHz <12ns	10W @ 50kHz <10ns
Laserklasse Laser Class	4		
Kühlung Cooling	Wasserkühlung oder ausschließlich Luftkühlung water-cooled or entirely air-cooled		
Kühlungsystem Cooling System	Thermo-elektrische Kühlung thermo-electric cooling		
Elektrischer Anschluss Electrical Ratings	24V DC		
Leistungsaufnahme Power Consumption	< 200W		

We reserve the right to make technical modifications without prior notice. Errors and omissions excepted.10% tolerances for measured values.

CONQUEROR ALL-IN-ONE Model 3 Lambda drawings (scale in mm)



^{*} average M² over the range of repetition rate

Product advantages of the CONQUEROR ALL-IN-ONE 3 Lambda

High quality through excellent beam quality

Diodepumped solid state laser

- State-of-the-art diode-pumped, q-switched solid state laser
- Software controlled triple wavelength selection:1064nm and 532nm and 355nm
- Extraordinary high wall-plug efficiency combined with smallest "footprint"
- Very high pulse peak power even at high repetition rates
- Extremely high efficiency due to direct excitation of single transversal mode (TEM₀₀)
- Optimized pulses due to external frequency conversion. Compared to internal frequency conversion, this features an important advantage: The damping factor of the pulses is reduced to a maximum. This results in a higher pulse- peak power at the same pulse length (FWHM) compared to internal frequency conversion. The heat effected zone (HAZ) is reduced to a minimum
- Multiple Pulse Control CMPSJ function
- Use of one single laser diode pump module only
- Modular architecture consisting of hermetically sealed modules. Due to the fact, that the conversion-module which generates UV laser light is independent and sealed from the main laser module, it is protected from out-gassing to the greatest extend for maximum life time
- Software driven THG-shifter (outstanding 1600 spots available!)
- Revolving output window for prolonged utility in harsh environments

Beam quality and reliability

- Single transversal mode TEM₀₀ of M² < 1.3 for all wavelengths
- Very good beam spot in focus yielding possibility of inducing a plasma in the air (optical breakdown) at 1Hz up to several kHz, depending on focusing alignment

Simple integration into production environment

An ultrasmall, compact. easy to use laser system, flexible in operation

- Easy installation into existing machines, minimum space required
- Consequently, no danger of damage of the laser and its accessories (for example gantry-systems) caused by leakage
- Medical approved, high density,100/230V AC - 24V DC power supply with ultra-small footprint
- Plug and work laser system designed to be ready for use almost immediately after delivery

Easy installation and straightforward operation

- Easy and fast Installation and integration into your existing production line regarding hardware as well as software
- Maximum choice of parameters, such as pulse form
- Possibility to control add-on-modules such as optional AOMs
- Control unit consisting of one single circuit board only

Low purchasing costs - low operating costs

Low operating • cost

- Use of one single laser pump module only
- Total system power consumption, less than 300W
- Very low heat emission even under permanent use
- Maintenance costs are reduced to a minimum
- No additional material and spare parts like lon exchangers, filters, cooling liquids etc. needed
- Estimated lifetime of the pump laser diode module: - 100,000 hours

Scientific and industrial application

Material processing and plasma monitoring

- Optimized for micro-processing of glass, sapphire, diamond, plastics, ceramics and metals like gold, copper, brass, steel etc.
- PCB cutting, drilling and depanelling
- Silicon micro machining, solar cell, ITO and LED processing
- Wavelength dependent spectroscopic and laser-material interaction studies (LIPS, MALDI, RAMAN)